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 Inputs Are TTL-Voltage Compatible Flow-Through Architecture Optimizes 	DW OR NT PACKAGE (TOP VIEW)
PCB Layout	1A 1 24 1B
 Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise 	1Y 2 23 1C 1Z 3 22 1D
 EPIC™ (Enhanced-Performance Implanted 	2Y 🛮 4 21 🗓 2A
CMOS) 1-μm Process ■ 500-mA Typical Latch-Up Immunity	GND[[5 20][2B GND[[6 19]]V _{CC}
at 125°C	GND[]7 18]] V _{CC} GND[]8 17]] 2C
 Package Options Include Plastic Small-Outline Packages and Standard 	2Z 9 16 2D
Plastic 300-mil DIPs	3Y
description	3D 12 13 3C

description

The 74ACT11802 contains three independent 4-input OR/NOR gates. They perform the Boolean functions in positive logic Y = A + B + C + D and $Z = \overline{A + B + C + D}$.

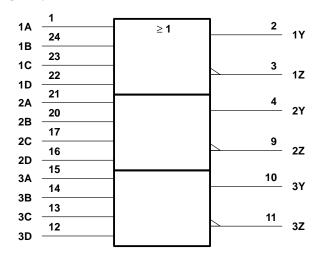
The 74ACT11802 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each 4-input gate)

INPUTS			OUT	PUTS	
Α	В	С	D	Y	Z
Н	Х	Х	Х	Н	L
Х	Н	Χ	Χ	Н	L
Х	Χ	Н	Χ	Н	L
Х	Χ	Χ	Н	Н	L
L	L	L	L	L	Н

logic symbol†

logic diagram, each section (positive logic)





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[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	$\dots \dots -0.5 \text{ V to 7 V}$
Input voltage range, V _I (see Note 1)	-0.5 V to $V_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±150 mA
Storage temperature range	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
VI	Input voltage	0		VCC	V
٧o	Output voltage	0		VCC	V
ЮН	High-level output current			-24	mA
loL	Low-level output current			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	ns/V
TA	Operating free-air temperature	-40		85	°C

NOTE 2: Unused or floating inputs must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V	T _A = 25°C			MIN	MAY	LINUT		
PARAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	IVIIIN	MAX	UNIT		
	ΙΟΗ = – 50 μΑ	4.5 V	4.4			4.4		V		
		5.5 V	5.4			5.4				
Voн	L 04 m4	4.5 V	3.94			3.8				
	I _{OH} = – 24 mA		4.94			4.8				
	$I_{OH} = -75 \text{ mA}^{\ddagger}$	5.5 V				3.85				
	I _{OL} = 50 μA				0.1		0.1			
	10[= 30 μΑ	5.5 V			0.1		0.1			
V _{OL}	I _{OL} = 24 mA	4.5 V			0.36		0.44	V		
		5.5 V			0.36		0.44			
	$I_{OL} = 75 \text{ mA}^{\ddagger}$	5.5 V					1.65			
ΙĮ	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ		
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ		
Δl _{CC} §	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			0.9		1	mA		
Ci	V _I = V _{CC} or GND	5 V		4				pF		

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.



NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

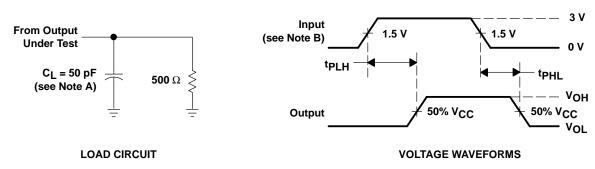
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX	IVIIIV	WAX	UNII
^t PLH	A, B, C, or D	D Y	1.3	6.1	8.4	1.3	9.5	no
^t PHL			1.3	4.8	7.4	1.3	8.1	ns
^t PLH	A, B, C, or D	7	1.3	4.6	7.5	1.3	8.3	20
tPHL		2	1	4.6	7.3	1	8.1	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per gate	$C_L = 50 \text{ pF}, f = 1 \text{ MHz}$	59	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , t_{f} = 3 ns, t_{f} = 3 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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